PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Matthias Peter	07/04/2012
Tobias Meyer	07/04/2012
Nikolaus Gmeinwieser	07/04/2012
Tetsuya Taki	07/09/2012
Hans-Jurgen Lugauer	07/04/2012
Alexander Walter	07/04/2012

RECEIVING PARTY DATA

Name:	OSRAM Opto Semiconductors GmbH	
Street Address:	Leibnizstrasse 4	
City:	Regensburg	
State/Country:	GERMANY	
Postal Code:	93055	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13519345

CORRESPONDENCE DATA

Fax Number: (215)656-2498 Phone: 215-656-3381 Email: pto.phil@dlapiper.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

501992760

Correspondent Name: T. Daniel Christenbury Address Line 1: One Liberty Place

Address Line 2: 1650 Market Street, Suite 4900 Address Line 4: Philadelphia, PENNSYLVANIA 19103

ATTORNEY DOCKET NUMBER: EHF-12-1106

PATENT

REEL: 028574 FRAME: 0652

NAME OF SUBMITTER:	Carol Coney
Total Attachments: 3 source=EHF-12-1106#page1.tif source=EHF-12-1106#page2.tif source=EHF-12-1106#page3.tif	

PATENT REEL: 028574 FRAME: 0653

ASSIGNMENT

WHEREAS, we, Matthias Peter, Tobias Meyer and Niklaus Gmeinwieser, citizens of Germany, Tetsuya Taki, citizen of Japan, and Hans-Jürgen Lugauer and Alexander Walter, citizens of Germany, respectively, residing at Diepenbrockstraße 1, 93055 Regensburg, Germany, Gronsdorfer Weg 25, 93346 Ihrlerstein, Germany, Embacherstraße 7, 93083 Obertraubling, Germany, Nippa 790, Kohoku-ku, 223-0057 Yokohama, Japan, Am Ehgarten 14, 93161 Sinzing, Germany and Weinbergweg 9, 93164 Laaber, Germany, respectively, (hereinafter referred to as "the undersigned"), having made an invention entitled OPTOELECTRONIC SEMICONDUCTOR CHIP AND USE OF AN INTERMEDIATE LAYER BASED ON AlGaN, identified in International Application No. PCT/EP2010/070274, and in US Application No. 13/519,345 (DLA Piper is authorized to insert the Serial No. when known),

WHEREAS, OSRAM Opto Semiconductors GmbH, with offices located at Leibnizstraße 4, 93055 Regensburg, Germany (hereinafter referred to as "the assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, do hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

Date

EHF-12-1106 / P2009,1597 US N (FNK/HBA)

ASSIGNMENT

WHEREAS, we, Matthias Peter, Tobias Meyer and Niklaus Gmeinwieser, citizens of Germany, Tetsuya Taki, citizen of Japan, and Hans-Jürgen Lugauer and Alexander Walter, citizens of Germany, respectively, residing at Diepenbrockstraße 1, 93055 Regensburg, Germany, Gronsdorfer Weg 25, 93346 Ihrlerstein, Germany, Embacherstraße 7, 93083 Obertraubling, Germany, Nippa 790, Kohoku-ku, 223-0057 Yokohama, Japan, Am Ehgarten 14, 93161 Sinzing, Germany and Weinbergweg 9, 93164 Laaber, Germany, respectively, (hereinafter referred to as "the undersigned"), having made an invention entitled OPTOELECTRONIC SEMICONDUCTOR CHIP AND USE OF AN INTERMEDIATE LAYER BASED ON AlGaN, identified in International Application No. PCT/EP2010/070274, and in US Application No. 13/519,345 (DLA Piper is authorized to insert the Serial No. when known),

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EXECUTED on the date(s) set forth below.

Date	Matthias Peter
Date	Tobias Meyer
4. July 2012 Date J	Nikolaus Gmeinwieser
Date .	Tetsuya Taki
Date	Hans-Jürgen Lugauer
Date	Alexander Walter

PATENT REEL: 028574 FRAME: 0655

EHF-12-1106 / P2009,1597 US N (FNK/HBA)

ASSIGNMENT

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EXECUTED on the date(s) set forth below.

Date	Matthias Peter
Date	Tobias Meyer
Date Or Ch. = 72	Nikolaus Gmeinwieser
09.07.2012 Date	Tetsuya Taki
Date	Hans-Jürgen Lugauer
Date	Alexander Walter

PATENT REEL: 028574 FRAME: 0656